

- Functionally Equivalent to AMD's AM29863
- Power-Up High-Impedance State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (NT) 300-mil DIPs

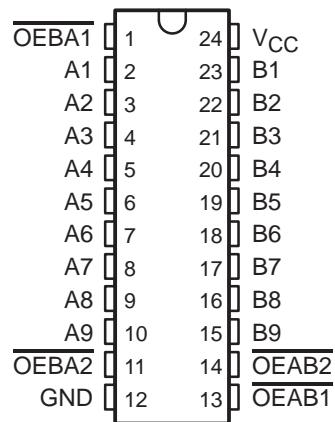
description

This 9-bit transceiver is designed for asynchronous two-way communication between data buses. The control-function implementation allows for maximum flexibility in timing.

This device allows data transmission from the A bus to the B bus or from the B bus to the A bus, depending on the logic levels at the output-enable (OEAB1, OEAB2, OEBA1, and OEBA2) inputs.

The SN74ALS29863 is characterized for operation from 0°C to 70°C.

DW OR NT PACKAGE
(TOP VIEW)



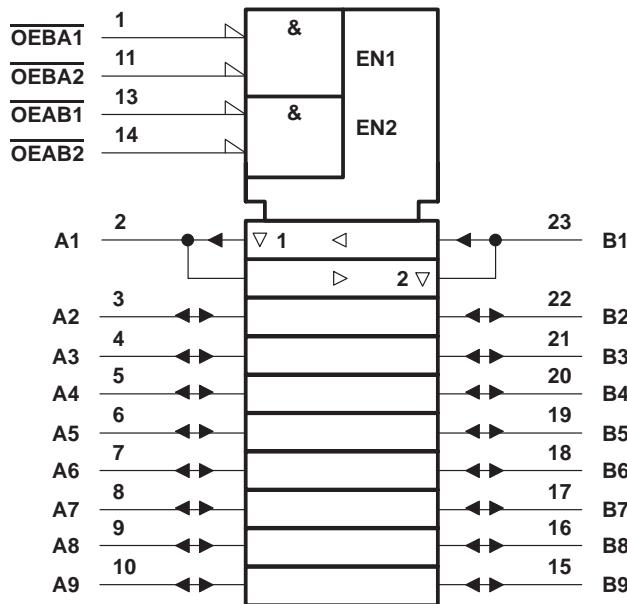
FUNCTION TABLE

INPUTS				OPERATION
OEAB1	OEAB2	OEBA1	OEBA2	
L	L	L	L	Latch A and B
L	L	H	X	
L	L	X	H	A to B
H	X	L	L	
X	H	L	L	B to A
H	X	H	X	
H	X	X	H	
X	H	X	H	
X	H	H	X	Isolation

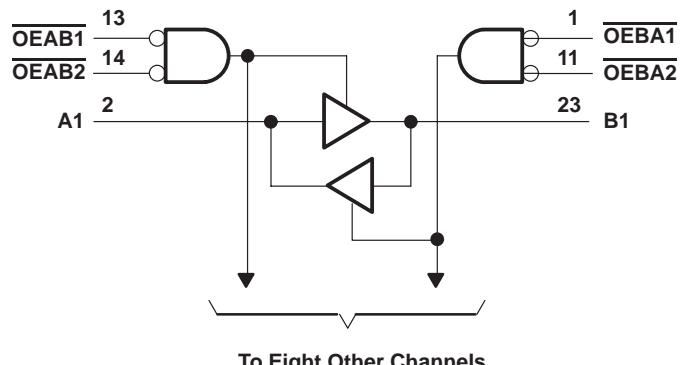
SN74ALS29863
9-BIT TRANSCEIVER
WITH 3-STATE OUTPUTS

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logic symbol†



logic diagram (positive logic)



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V_{CC}	7 V
Input voltage, V_I (all inputs and I/O ports)	5.5 V
Operating free-air temperature range, T_A	0°C to 70°C
Storage temperature range	-65°C to 150°C

‡ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

		MIN	NOM	MAX	UNIT
V_{CC}	Supply voltage	4.75	5	5.25	V
V_{IH}	High-level input voltage	2			V
V_{IL}	Low-level input voltage			0.8	V
I_{OH}	High-level output current			-24	mA
I_{OL}	Low-level output current			48	mA
T_A	Operating free-air temperature	0		70	°C

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		MIN	TYP†	MAX	UNIT	
V_{IK}	$V_{CC} = 4.75 \text{ V}$, $I_I = -18 \text{ mA}$				-1.2	V	
V_{OH}	$V_{CC} = 4.75 \text{ V}$	$I_{OH} = -15 \text{ mA}$		2.4		V	
		$I_{OH} = -24 \text{ mA}$		2			
V_{OL}	$V_{CC} = 4.75 \text{ V}$, $I_{OL} = 48 \text{ mA}$			0.35	0.5	V	
I_I	$V_{CC} = 5.25 \text{ V}$, $V_I = 5.5 \text{ V}$			0.1		mA	
I_{IH}	Control inputs	$V_{CC} = 5.25 \text{ V}$, $V_I = 2.7 \text{ V}$			20	μA	
	A or B ports‡				20		
I_{IL}	Control inputs	$V_{CC} = 5.25 \text{ V}$, $V_I = 0.4 \text{ V}$			-0.1	mA	
	A or B ports‡				-0.1		
$I_{OS}§$	$V_{CC} = 5.25 \text{ V}$, $V_O = 0$			-75	-250	mA	
I_{CC}	$V_{CC} = 5.25 \text{ V}$			40	65	mA	

† All typical values are at $V_{CC} = 5 \text{ V}$, $T_A = 25^\circ\text{C}$.

‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

§ Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

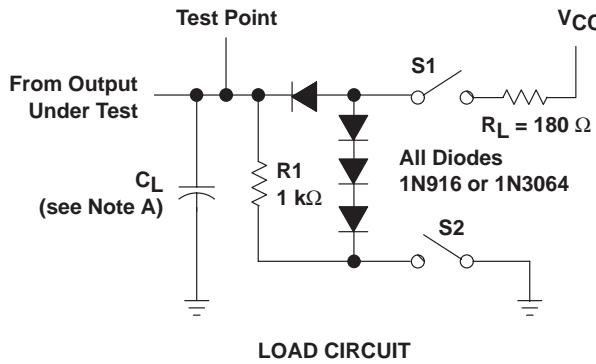
switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	$V_{CC} = 4.75 \text{ V to } 5.25 \text{ V}$		UNIT
				MIN	MAX	
t_{PLH}	A or B	B or A	$C_L = 300 \text{ pF}$		15	ns
					15	
t_{PLH}	A or B	B or A	$C_L = 50 \text{ pF}$		8	ns
					8	
t_{PZH}	\overline{OEAB} or \overline{OEBA}	A or B	$C_L = 300 \text{ pF}$		20	ns
					23	
t_{PZL}	\overline{OEAB} or \overline{OEBA}	A or B	$C_L = 50 \text{ pF}$		15	ns
					15	
t_{PHZ}	\overline{OEAB} or \overline{OEBA}	A or B	$C_L = 50 \text{ pF}$		17	ns
					12	
t_{PLZ}	\overline{OEAB} or \overline{OEBA}	A or B	$C_L = 5 \text{ pF}$		9	ns
					9	

SN74ALS29863
9-BIT TRANSCEIVER
WITH 3-STATE OUTPUTS

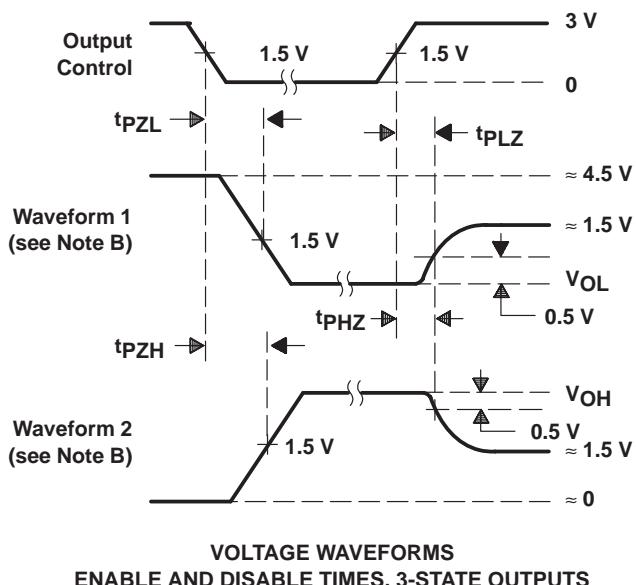
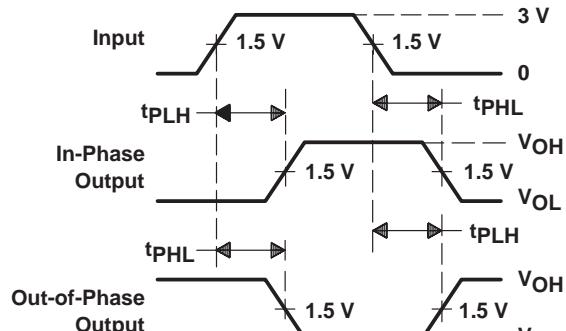
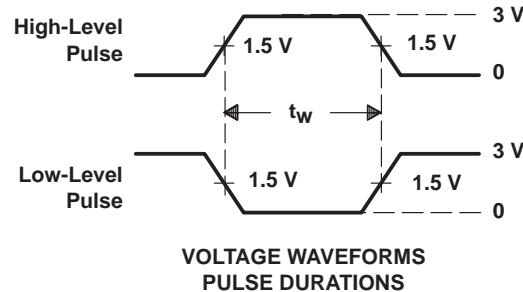
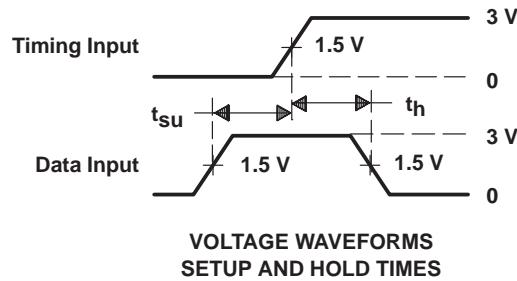
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PARAMETER MEASUREMENT INFORMATION



SWITCH POSITION TABLE

TEST	S1	S2
t_{PLH}	Closed	Closed
t_{PHL}	Closed	Closed
t_{PZH}	Open	Closed
t_{PZL}	Closed	Open
t_{PHZ}	Closed	Closed
t_{PLZ}	Closed	Closed



NOTES: A. C_L includes probe and jig capacitance.
 B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 C. All input pulses are supplied by generators having the following characteristics: PRR $\leq 10\text{ MHz}$, $Z_O = 50\ \Omega$, $t_r \leq 2.5\text{ ns}$, $t_f \leq 2.5\text{ ns}$.

Figure 1. Load Circuit and Voltage Waveforms

PACKAGING INFORMATION

Orderable Device	Status ⁽¹⁾	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/Ball Finish	MSL Peak Temp ⁽³⁾
SN74ALS29863DW	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWE4	ACTIVE	SOIC	DW	24	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWR	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863DWRE4	ACTIVE	SOIC	DW	24	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74ALS29863NT	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74ALS29863NTE4	ACTIVE	PDIP	NT	24	15	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

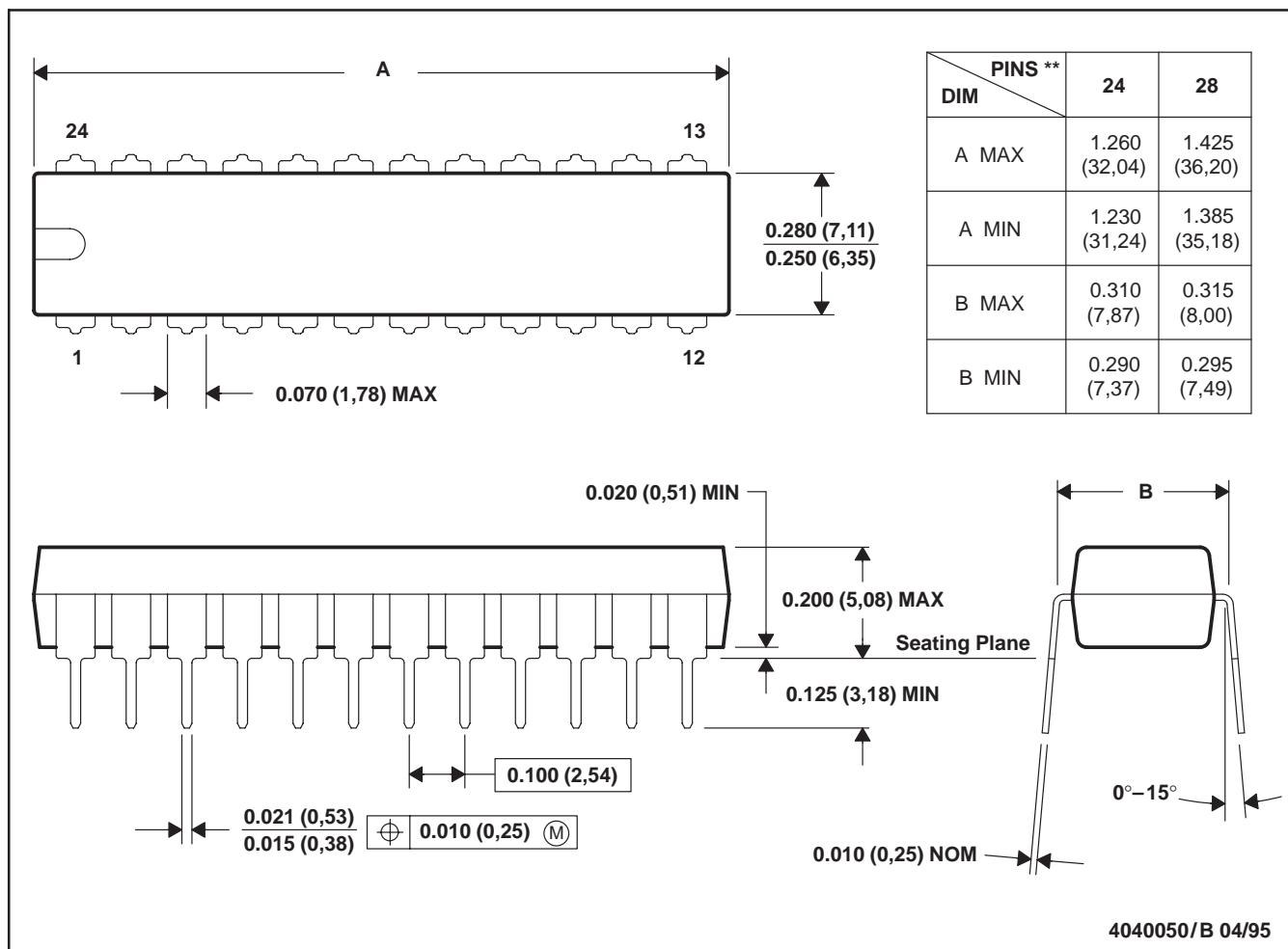
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NT (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

24 PINS SHOWN

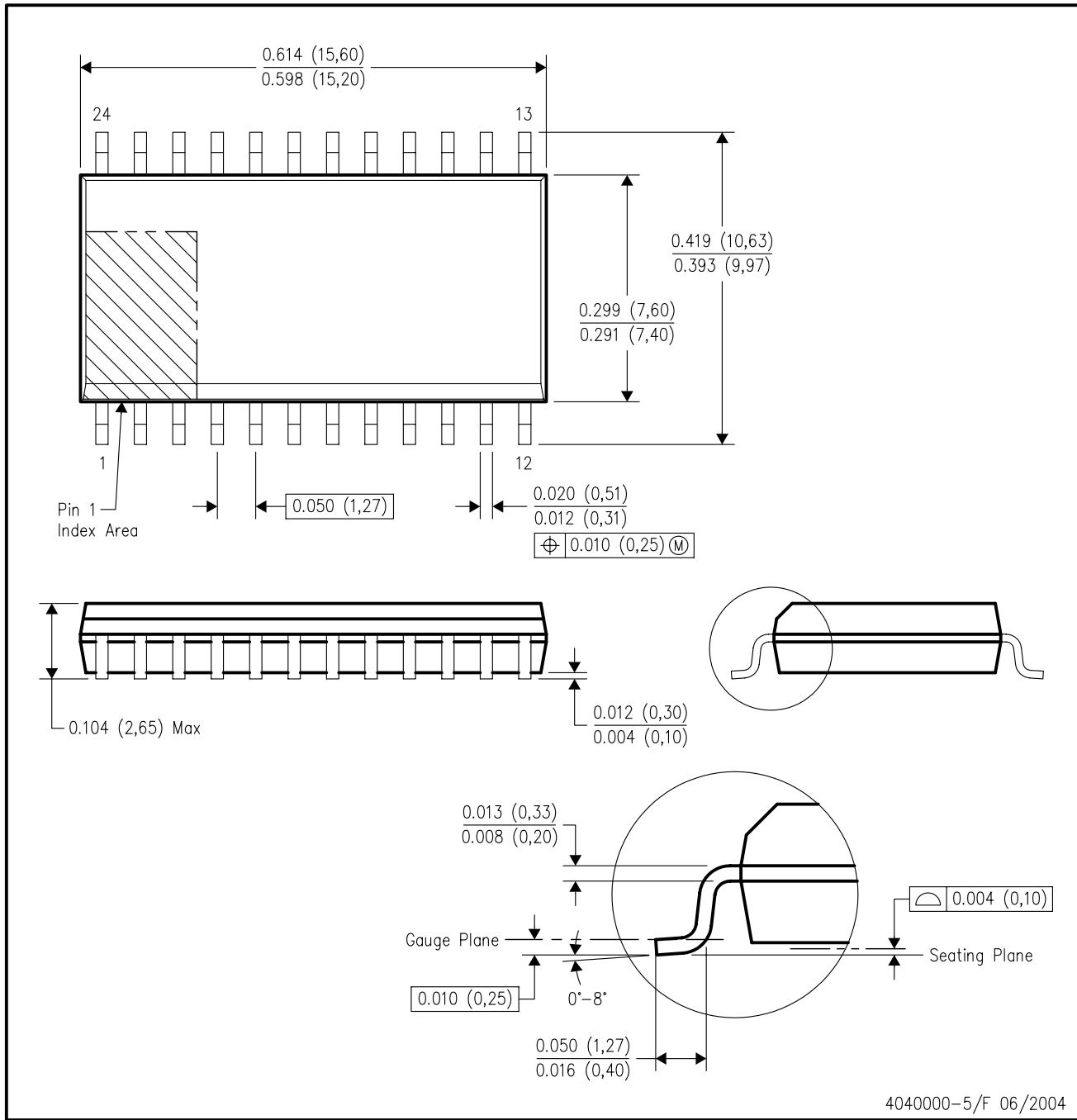


NOTES: A. All linear dimensions are in inches (millimeters).

B. This drawing is subject to change without notice.

DW (R-PDSO-G24)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0.15).
- Falls within JEDEC MS-013 variation AD.

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